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Attorney Reference Number 6319-56134
Application Number 09/660,753

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Response Under 37 C.F.R. § 1.116 Expedited Procedure

In re application of: Chang, Chin-Huang

Art Unit: 1756

Application No. 09/660,753

Filed: September 13, 2000

For: METHOD FOR REDUCING SIZE OF
SEMICONDUCTOR UNIT IN
PACKAGING PROCESS

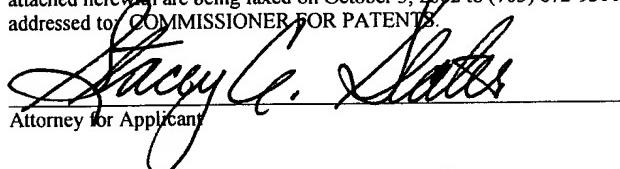
Examiner: Lan Vinh

Date: October 3, 2002

COMMISSIONER FOR PATENTS
Washington, DC 20231

CERTIFICATE OF FACSIMILE

I hereby certify that this paper and the documents referred to as being attached herewith are being faxed on October 3, 2002 to (703) 872-9311 addressed to COMMISSIONER FOR PATENTS.


Stacy L. Slaters
Attorney for Applicant

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AMENDMENT AFTER FINAL REJECTION

This responds to the Advisory Action dated September 20, 2002, concerning the application referenced above. Please amend the application as follows.

In the Claims:

Please amend the claims as follows.

1. (Amended) A method for reducing the size of at least a semiconductor unit in a process of making a package including a carrier and said semiconductor unit, said semiconductor unit including a first surface and a second surface, said second surface having no electrical connection device thereon, said method comprising:

attaching at least a part of said first surface to said carrier; and

etching said semiconductor unit from said second surface to reduce semiconductor unit